# Overview of the Roadmap Scope and Outline

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# **Purpose of Our Activity**

To identify R&D problems in the field of Energy Efficient Computation for automated vehicles (AV) that are suitable for public and private investment.

#### Approach:

- ✓ Assemble an "Organizing Team" of representatives from academia, industry and national labs to develop a "content outline" ("roadmap outline") for a EECAV Roadmap.
- ✓ Identify the R&D challenges to computational energy efficiency that must be overcome for the realization of highly automated driving in commercial retail vehicles with lower power consumption.
- ✓ Focus on the long-term, typical of public investment and atypical of current industrial investments.
- ✓ Use the roadmap outline as an initial "seed" to a more comprehensive energy efficient computing road mapping activity in a second phase that will likely include broader partners.
- ✓ Perform honest technical assessment without bias or favoritism to a particular technology, ensuring a technically sound input for an eventual long-term EECAV roadmap that can guide R&D investment.



# **Schedule That We Have Been Following**





## First Step: Literature Review

## Has Anybody Done Something Like This Before? Answer: No

We searched the technical literature for articles relating to computational energy and AV: Several dozen articles were found.

#### **Result:**

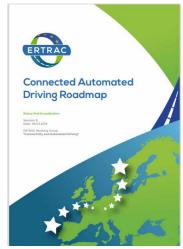
None of these articles, or reviews, discuss the supply\* part of our problem. They all assume the computational capability will be there. A few articles discuss the demand\* side of our problem, namely the sensor/camera data that must be processed computationally. There is no discussion of computational energy efficiency. Thus, we are not re-inventing the wheel.

\*Computational Supply: The capability of the chip to perform algorithms and functions (TOPs) for self-driving.

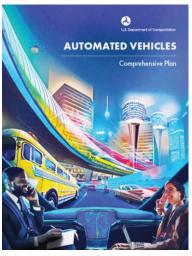
Computational Demand: The demand on computation from AV features, AV functionalities, operating design domains, etc.

The literature review will be an appendix to our Roadmap Outline, which will be published.

## **High-level AV "Timelines" From Different Countries**



EU (2019) Full AV beyond 2030



United States (2021) Full AV "unknown"



(2016)

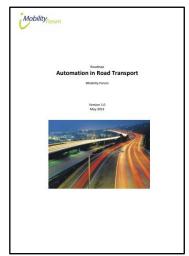
Full AV ~ 2030



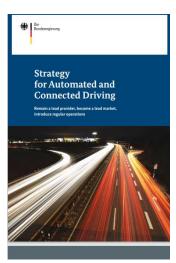
UK (2019) *Full AV ~ 2030* 



Canada (2019) Full AV "uncertain"



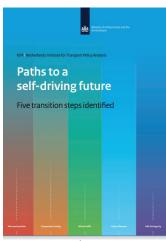
EU (2013) *Full AV ~ 2029* 



Germany (2015) Full AV beyond 2030



Japan (2016) Full AV in 2050



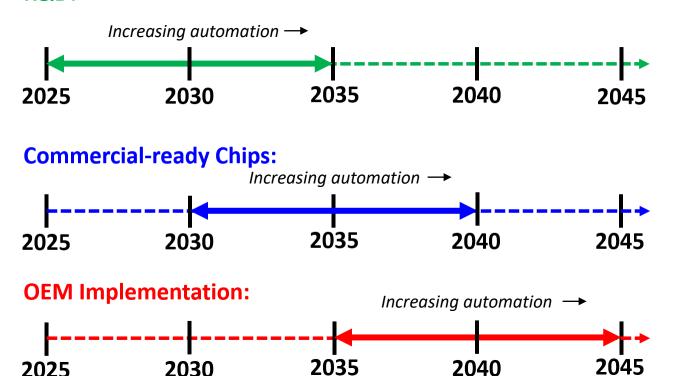
The
Netherlands
(2016)
Full AV ~ 2065



## There are 3 Timelines to Track

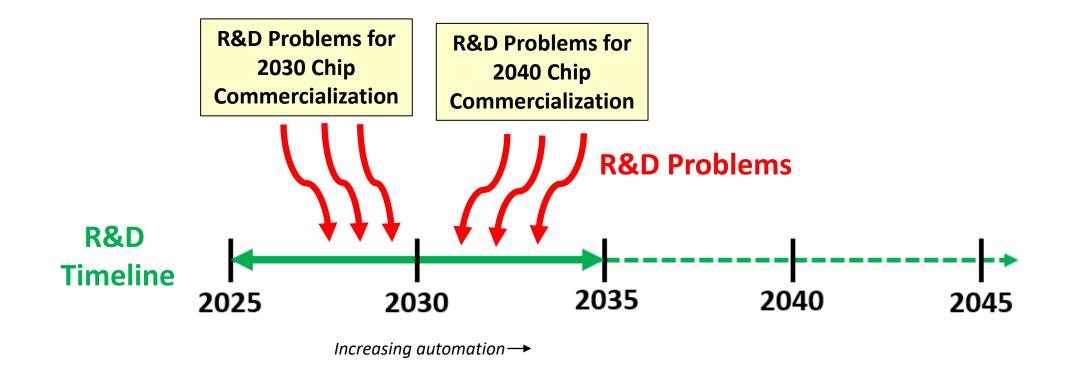
#### We thought about the roadmap outline in terms of 3 conceptually distinct timelines:

- The Timeline for establishing commercial-ready compute system for AV computation
- The Timeline for the R&D that enables these system
- The Timeline for OEM implementation of those system in future <u>mass-produced</u> AV. R&D:





# We Identify R&D Problems and Place Them on the R&D Timeline





# The R&D Problems are Organized into 4 Technical Areas

- I. Chips: Materials, Devices and Circuits (Lead: John Paul Strachan, HPE, now Forschungzentrum Jülich )
- II. Chips: Architecture, Safety and Security (Lead: Rob Aitken, ARM)
- III. Algorithms and Data Management (Lead: Robert Dick, UMichigan)
- IV. Sensors Data Interface (Lead: Jace Mogill, USCAR)
- -- Each Team worked offline to identify R&D Gaps within their Technical Areas, particularly problems with a long-term focus. The R&D problems were then brought to the entire Organizing Team for discussion and priority ranking.



### We Need Your Feedback On.....

We are needing your feedback on some basic underlying assumptions we made, difficulties we encountered, and the R&D problems we have identified.

#### Assumptions:

e.g., all the required computational capability resides on the vehicle.

#### **Difficulties:**

e.g., making quantitative the needed improvements in the 4 Technical Areas.

#### **R&D Problems:**

Will be described for each Technical Area I - IV.

We need your feedback on the R&D problem areas we have identified. We are not looking for technical solutions. We are working in the "problem space" to identify R&D areas that would benefit from public and private investment.

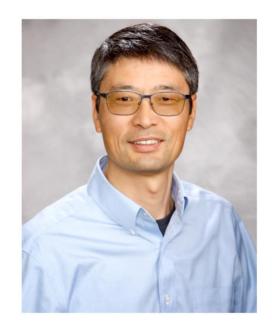


### Thank You!





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